



Parameter	Rating	Units
Blocking Voltage	350	$V_p$
Load Current	120	$mA_{rms} / mA_{DC}$
On-Resistance (max)	30	$\Omega$
LED Current to operate	2	mA

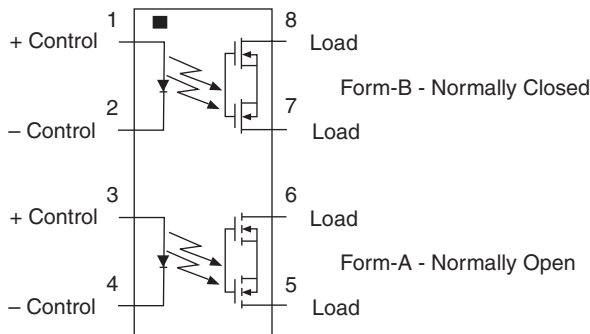
### Features

- 1500V<sub>rms</sub> Input/Output Isolation
- Small 8-Pin SOIC Package
- TTL/CMOS Compatible input
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Immune to radiated EM fields
- SMD Pick & Place, Wave Solderable
- Tape & Reel Version Available

### Applications

- Telecommunication
- Security
  - Passive Infrared Detectors (PIR)
  - Data Signalling
  - Sensor Circuitry
- Instrumentation
  - Multiplexers
  - Data Acquisition
  - Electronic Switching
  - I/O Subsystems
- Medical Equipment—Patient/Equipment Isolation
- Aerospace
- Industrial Controls

### Pin Configuration



### Description

The CPC2330N is a miniature device with two independent solid state relays, one normally open (1-Form-A) and the other normally closed (1-Form-B), in an 8-pin SOIC package with 1500V<sub>rms</sub> of input to output isolation.

The optically coupled outputs, which use IXYS Integrated Circuits Division's patented OptoMOS architecture, are controlled by a highly efficient GaAIAs infrared LED.

Using IXYS Integrated Circuits Division's state of the art, double-molded vertical construction packaging, the CPC2330N is ideal for replacing larger less-reliable reed and electromechanical relays.

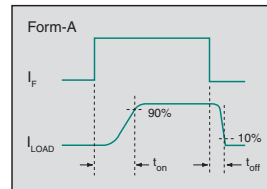
### Approvals

- UL Recognized Component: File E76270
- EN/IEC 60950-1 Certified Component: TUV Certificate B 09 07 49410 004

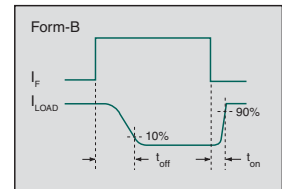
### Ordering Information

Part #	Description
CPC2330N	8-Pin SOIC (50/tube)
CPC2330NTR	8-Pin SOIC (2000/reel)

Switching Characteristics of Normally Open Devices



Switching Characteristics of Normally Closed Devices



### Absolute Maximum Ratings @ 25°C

Parameter	Ratings	Units
Blocking Voltage	350	V <sub>P</sub>
Reverse Input Voltage	5	V
Input Control Current Peak (10ms)	50	mA
	1	A
Total Power Dissipation <sup>1</sup>	600	mW
Isolation Voltage, Input to Output	1500	V <sub>rms</sub>
ESD Rating, Human Body Model	8	kV
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C
Soldering Temperature (10 Seconds)	260	°C

<sup>1</sup> Derate linearly 5.0 mW / °C

*Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.*

### Electrical Characteristics @ 25°C

Parameter	Conditions	Symbol	Min	Typ	Max	Units
<b>Output Characteristics</b>						
Load Current						
Form-A, Continuous <sup>1</sup>	I <sub>F</sub> =2mA	I <sub>L</sub>	-	-	120	mA <sub>rms</sub> / mA <sub>DC</sub>
Form-B, Continuous <sup>1</sup>	I <sub>F</sub> =0mA					
Peak	t = 10ms	I <sub>LPK</sub>	-	-	±350	mA <sub>P</sub>
On-Resistance <sup>2</sup>	I <sub>L</sub> =120mA	R <sub>ON</sub>	-	-	30	Ω
Switching Speeds						
Turn-On	I <sub>F</sub> =5mA, V <sub>L</sub> =10V	t <sub>on</sub>	-	-	3	ms
Turn-Off		t <sub>off</sub>	-	-	3	
Off-State Leakage Current						
Form-A	I <sub>F</sub> =0mA, V <sub>L</sub> =350V <sub>P</sub>	I <sub>LEAK</sub>	-	0.001	1	μA
Form-B	I <sub>F</sub> =2mA, V <sub>L</sub> =350V <sub>P</sub>		-	2	5	
Output Capacitance						
Form-A	I <sub>F</sub> =0mA, V <sub>L</sub> =50V, f=1MHz	C <sub>OUT</sub>	-	9	-	pF
Form-B	I <sub>F</sub> =5mA, V <sub>L</sub> =50V, f=1MHz			6		
<b>Input Characteristics</b>						
Input Control Current to Activate <sup>3</sup>	I <sub>L</sub> =120mA	I <sub>F</sub>	-	-	2	mA
Input Control Current to Deactivate	-	I <sub>F</sub>	0.1	-	-	mA
Input Voltage Drop	I <sub>F</sub> =5mA	V <sub>F</sub>	0.9	1.2	1.4	V
Reverse Input Current	V <sub>R</sub> =5V	I <sub>R</sub>	-	-	10	μA
<b>Common Characteristics</b>						
Capacitance, Input to Output	-	-	-	1	-	pF

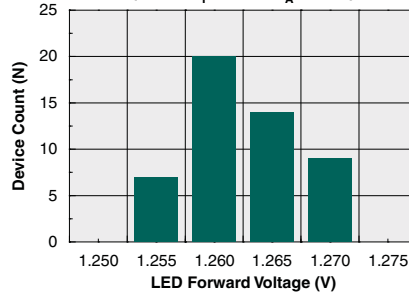
<sup>1</sup> Load current derates linearly from 120mA @ 25°C to 60mA @ 85°C, and must be derated for both poles operating simultaneously.

<sup>2</sup> Measurement taken within 1 second of on-time.

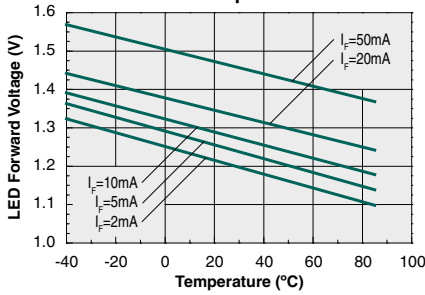
<sup>3</sup> For applications requiring high temperature operation (greater than 60°C) an LED drive current of 4mA is recommended.

### FORM-A & FORM-B PERFORMANCE DATA\*

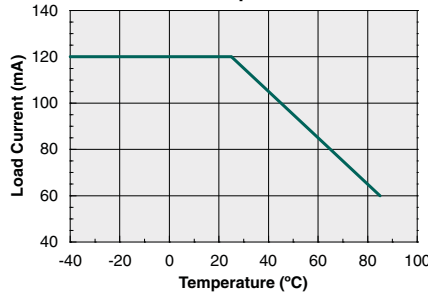
Typical LED Forward Voltage Drop  
(N=50,  $I_F=5\text{mA}$ ,  $T_A=25^\circ\text{C}$ )



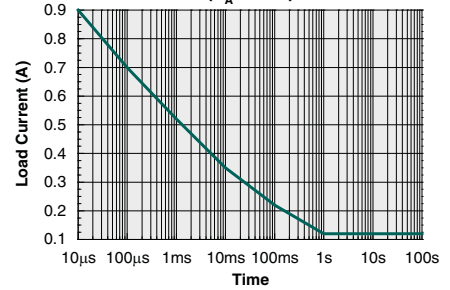
Typical LED Forward Voltage Drop vs. Temperature



Maximum Load Current vs. Temperature

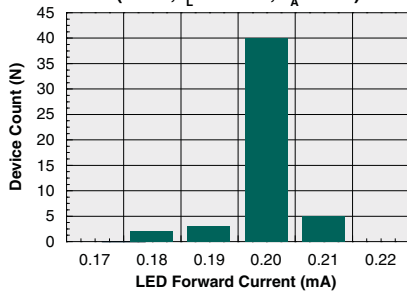


Energy Rating Curve  
( $T_A=25^\circ\text{C}$ )

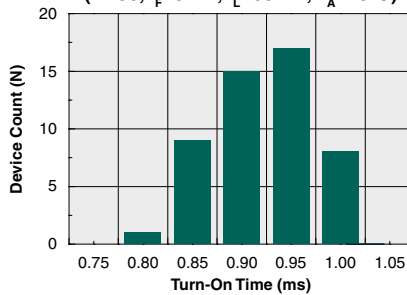


### FORM-A PERFORMANCE DATA\*

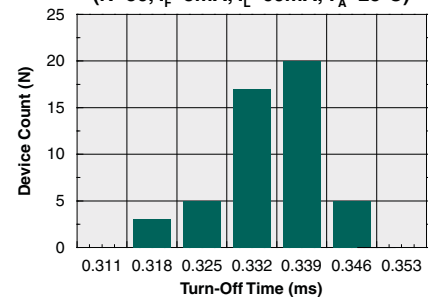
Typical  $I_F$  for Switch Operation  
(N=50,  $I_L=120\text{mA}$ ,  $T_A=25^\circ\text{C}$ )



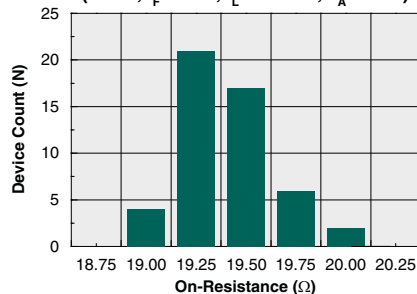
Typical Turn-On Time  
(N=50,  $I_F=5\text{mA}$ ,  $I_L=60\text{mA}$ ,  $T_A=25^\circ\text{C}$ )



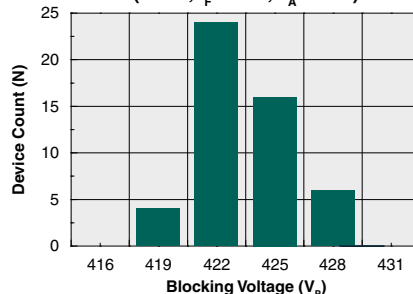
Typical Turn-Off Time  
(N=50,  $I_F=5\text{mA}$ ,  $I_L=60\text{mA}$ ,  $T_A=25^\circ\text{C}$ )



Typical On-Resistance Distribution  
(N=50,  $I_F=2\text{mA}$ ,  $I_L=120\text{mA}$ ,  $T_A=25^\circ\text{C}$ )

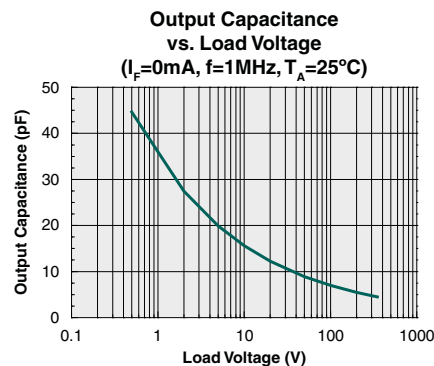
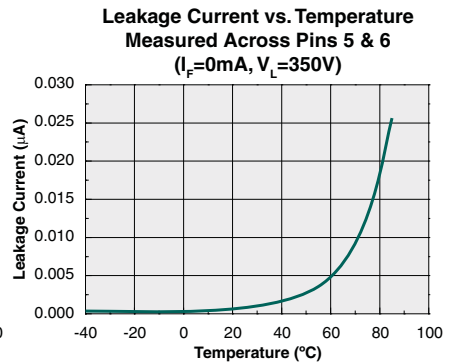
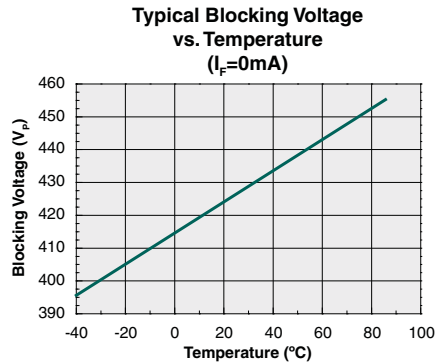
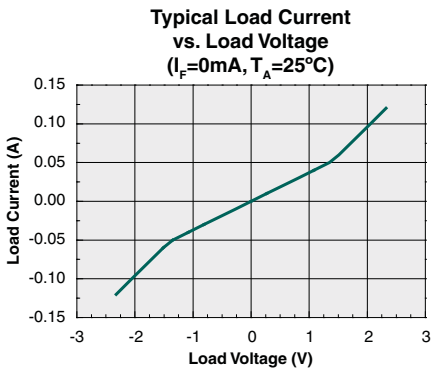
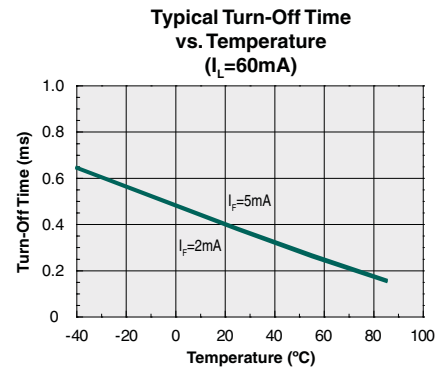
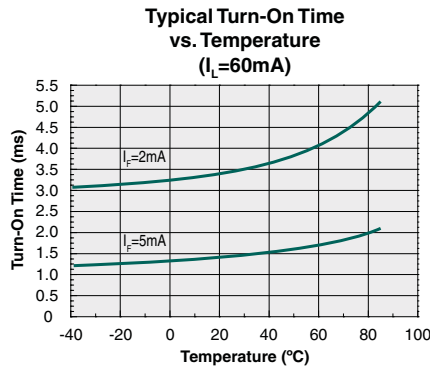
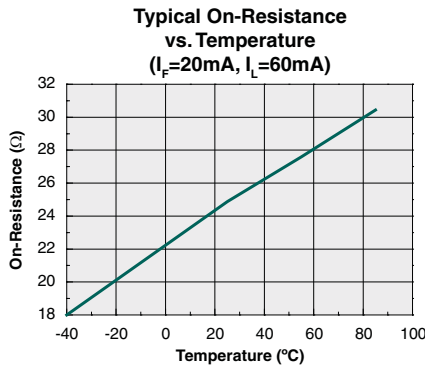
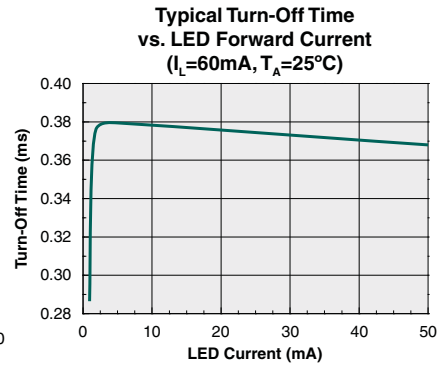
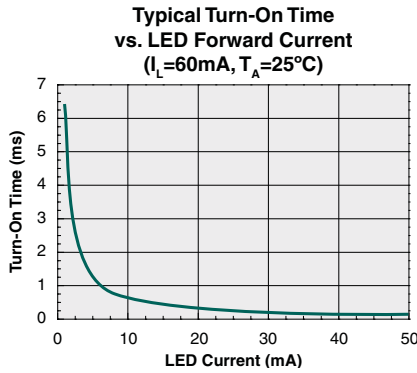
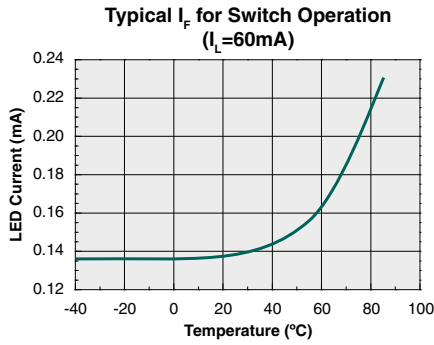


Typical Blocking Voltage Distribution  
(N=50,  $I_F=0\text{mA}$ ,  $T_A=25^\circ\text{C}$ )



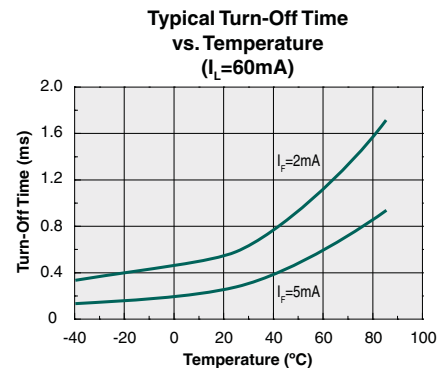
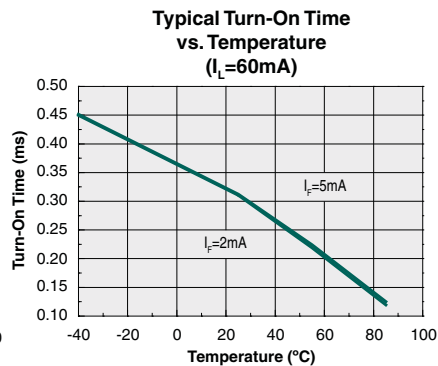
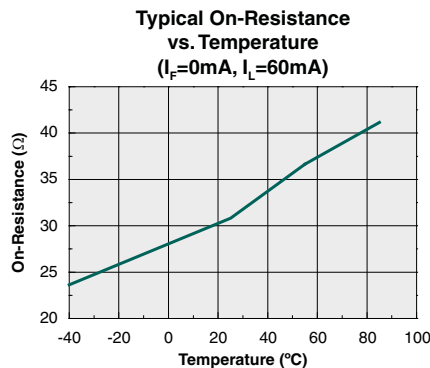
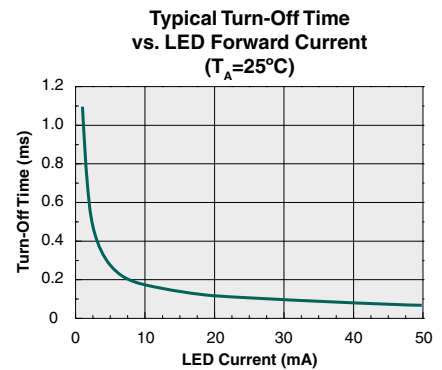
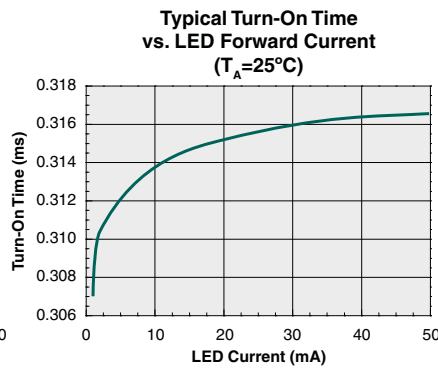
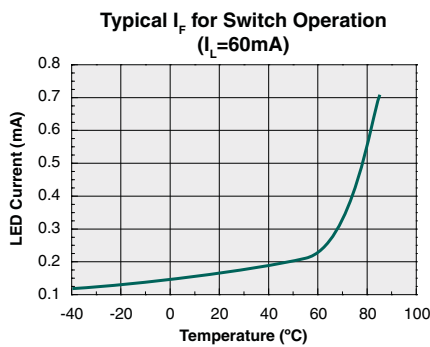
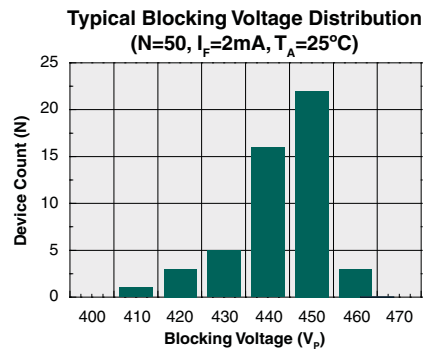
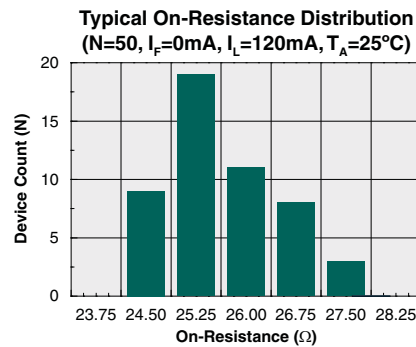
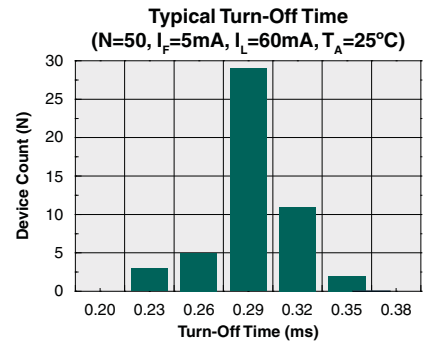
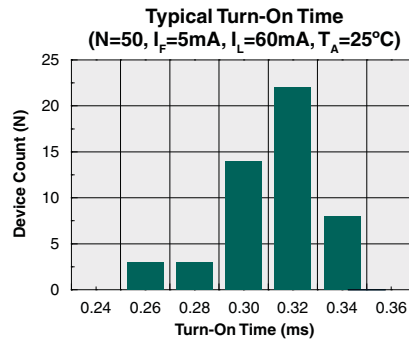
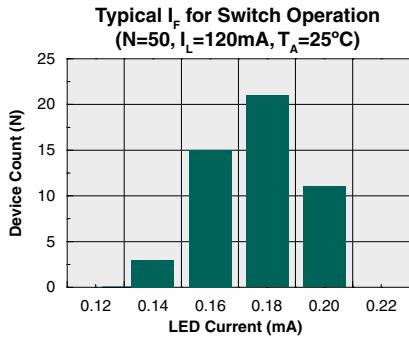
\*The Performance Data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

FORM-A PERFORMANCE DATA (Cont.)\*



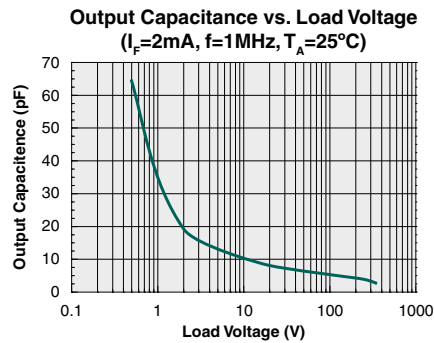
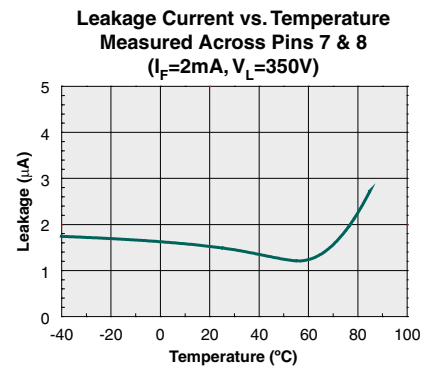
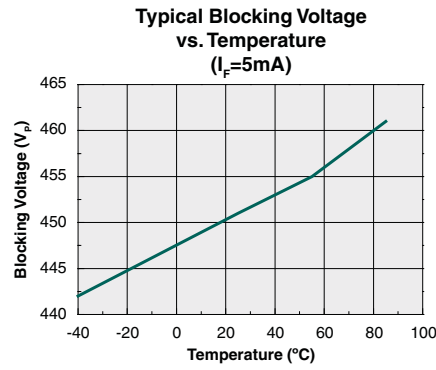
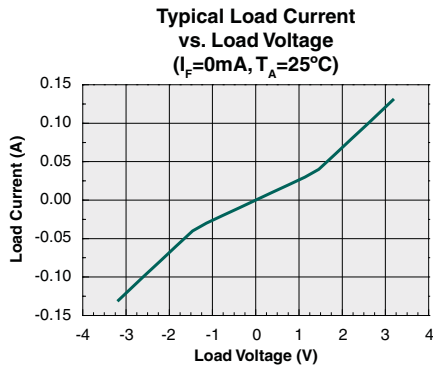
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FORM-B PERFORMANCE DATA\*



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FORM-B PERFORMANCE DATA (Cont.)\*



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## Manufacturing Information

### Moisture Sensitivity



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
CPC2330N	MSL 3

### ESD Sensitivity



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

### Reflow Profile

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
CPC2330N	260°C for 30 seconds

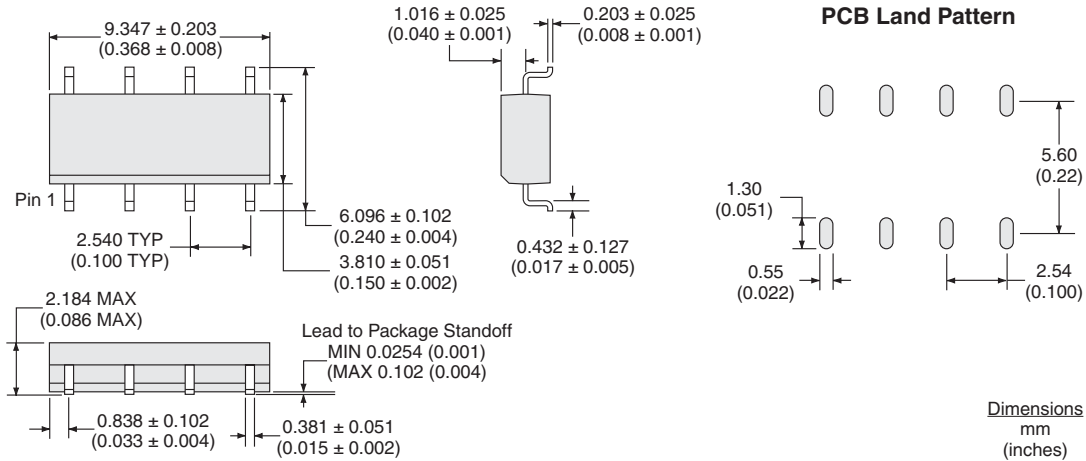
### Board Wash

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

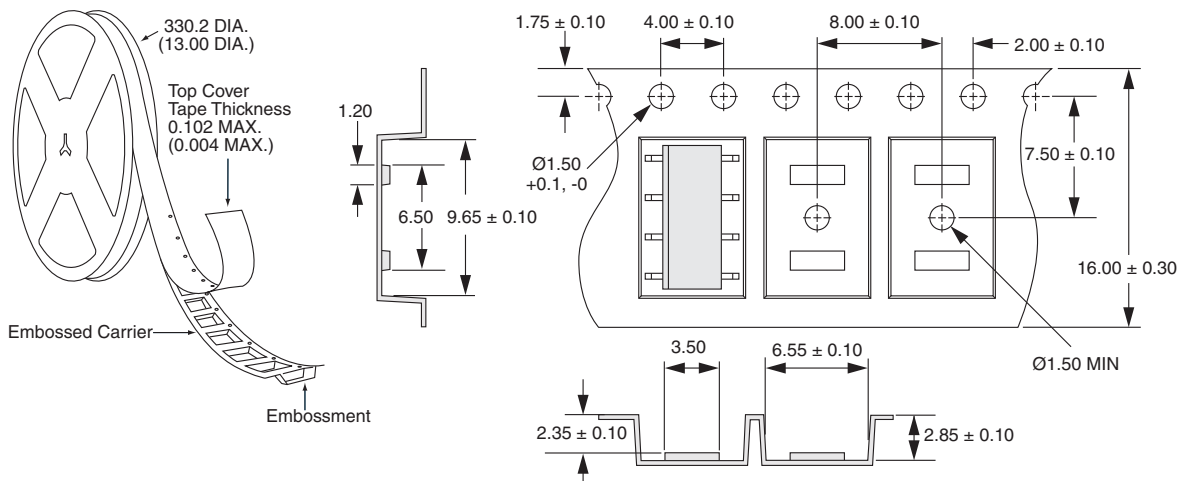


### Mechanical Dimensions

#### CPC2330N



#### CPC2330NTR Tape & Reel



**NOTES:**

1. All dimensions in millimeters
2. 10 sprocket hole pitch cumulative tolerance ± 0.20.
3. Carrier camber is within 1mm in 250mm.
4. Tape material : Black Conductive Polystyrene Alloy.
5. All dimensions meet EIA-481-C requirements.
6. Thickness : 0.30 ± 0.05mm.

**For additional information please visit our website at: [www.ixysic.com](http://www.ixysic.com)**

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